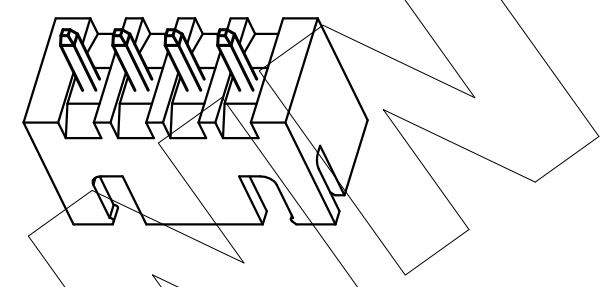
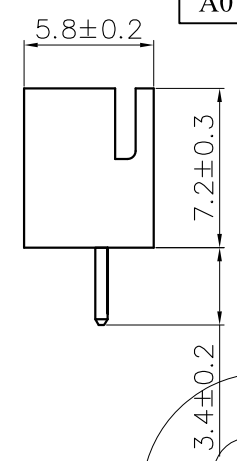
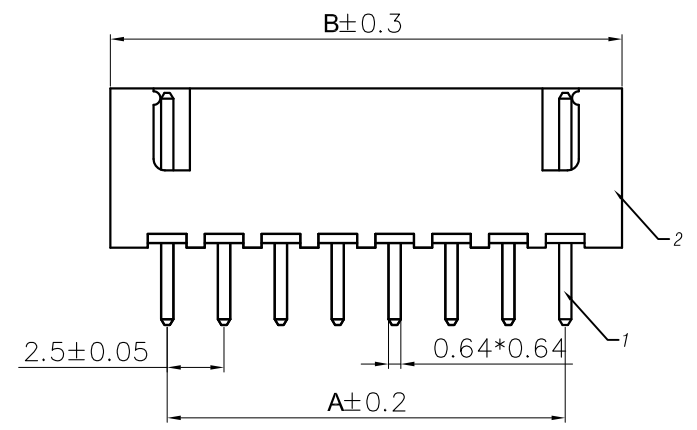


零件图	成品图	客户图
		○

REVISION DATA

REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	Zhang	2017-04-21

poles	A	B
2	2.50	7.50
3	5.00	10.00
4	7.50	12.50
5	10.00	15.00
6	12.50	17.50
7	15.00	20.00
8	17.50	22.50
9	20.00	25.00
10	22.50	27.50
11	25.00	30.00
12	27.50	32.50
13	30.00	35.00
14	32.50	37.50
15	35.00	40.00
16	37.50	42.50

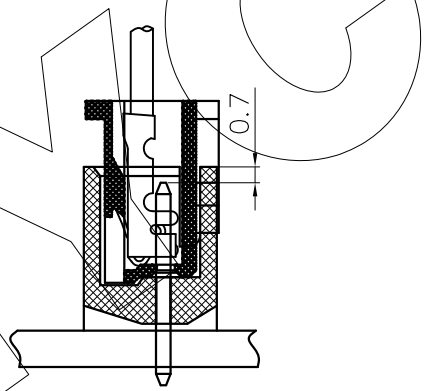
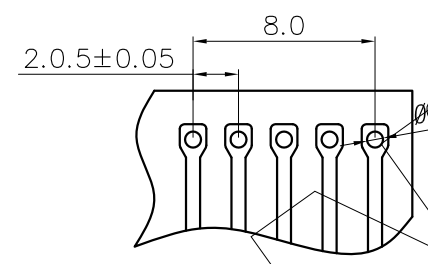


Technical Data

Material:  
 Contact Material: Copper Alloy  
 Contact plating: Au or Sn Over Ni  
 Insulator Material: See the table, UL94 V-0

Electrical:  
 Rating current: 3Amps/contact max.  
 Rating voltage : 250 V AC/DC  
 Contact resistance: ≤20mΩ/contact  
 Insulation resistance: ≥1000MΩ  
 Withstanding Voltage: 1000V AC/minute

Mechanical:  
 Operating temperatures: Gold Plated: -55°C to +105°C  
 Tin plated: -40°C to +105°C  
 Soldering temperature: +260°C, max(PA66)  
 +220°C, max(PBT)



Recommended P.B.C. Layout

WF	A	D	11	XXX	XX	X	N	D011
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A PH 2.5	D 180°
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Pin No.  
 Product Type  
 11 Single row

Pin No.  
 No. of Positions  
 XXX Positions

PLATED  
 SN Tin 120 μ"  
 T3 MATTE Sn

MATERIAL  
 A PBT  
 B PA-66  
 C PA-6T  
 D LCP  
 E PA-46  
 F PA-9T  
 H PA4T

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**东莞市恩康电子科技有限公司**  
**DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD**

TOLERANCE	DATE :	TITLE:
ANGLE ±5°	DRAWN :	PH2.5 H7.2 W5.8 180° WAFER
X.XXX ±0.15	CHECKED :	PART NO: WFAD11XXXXXXND011
X.XX ±0.25	Zhang	
X.X ±0.40	APPROVED :	
X. ±0.50	PROJECTON	REV: A0
		UNIT: mm
		SCALE: 1:1
		SIZE: A4
		PAGE: 1/1